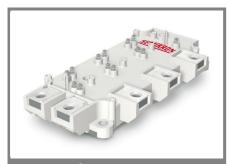
SEMIX 341D...



SEMiX[®] 13s

Bridge Rectifier Module (uncontrolled)

SEMiX 341D

Target Data

Features

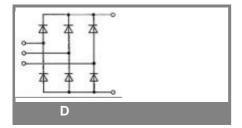
- terminal height of 17mm
- chip solder on direct copper
- bonded Al_2O_3 ceramic heat transfer through Al_2O_3 ceramic isolated baseplate

Typical Applications

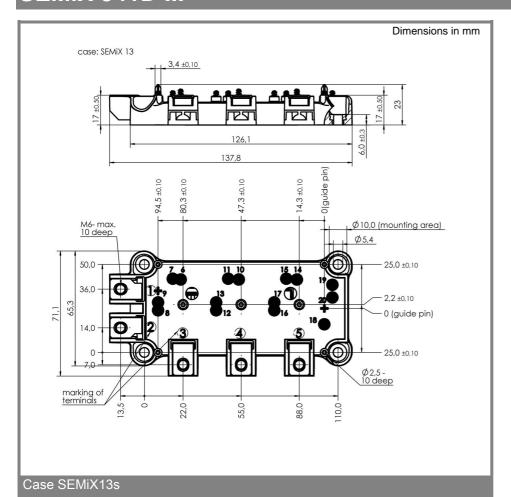
- Input Bridge Rectifier for
- AC/DC motor control
- power supply

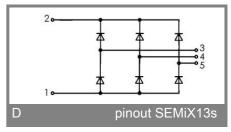
V _{RSM}	V _{RRM} , V _{DRM}	I _D = 340 A (full conduction)
V	V	(T _c = 85 °C)
1700	1600	

Symbol	Conditions	Values	Units
I _D	T _c = 85 °C	340	Α
	T _C = 100 °C	290	
I _{FSM}	T _{vi} = 25 °C; 10 ms	2500	А
	T _{vi} = 130 °C; 10 ms	2000	Α
i²t	T _{vj} = 25 °C; 8,3 10 ms	31200	A²s
	T _{vj} = 130 °C; 8,3 10 ms	20000	A²s
V _F	T _{vi} = 25 °C; I _F = 400 A	max. 1,75	V
$V_{(TO)}$	T _{vi} = 130 °C	max. 0,9	V
r _T	T _{vi} = 130 °C	max. 2,7	mΩ
I_{RD}	T_{vj} = 130 °C; $V_{DD} = V_{DRM}$; $V_{RD} = V_{RRM}$	max. 4,5	mA
			mA
R _{th(j-c)}	per diode	0,22	K/W
tri(j-c)		-,	K/W
R _{th(c-s)}	per module	0,04	K/W
T _{vi}	·	- 40 + 130	°C
T _{stg}		- 40 + 125	°C
V _{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	4800 (4000)	V
Ms	(min./max.)	3/5	Nm
M _t	(min./max.)	2,5/5	Nm
a		5 * 9,81	m/s²
m		300	g
Case	SEMiX 13s		



SEMIX 341D...





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